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AF/GP 28264

PATENT

DOCKET NO. 97-C-108  
Customer No. 30425

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: : Tsiu Chiu Chan, et al.  
Serial No. : 09/160,824  
Filed : September 25, 1998  
For : STACKED MULTI-COMPONENT INTEGRATED CIRCUIT  
MICROPROCESSOR  
Group No. : 2826  
Examiner : T. Dickey

**BOX AF**  
Commissioner for Patents  
Washington, D.C. 20231

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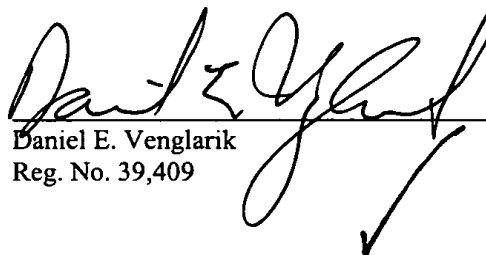
Sir:

The undersigned hereby certifies that the following documents:

1. Notice of Appeal;
2. Petition for Extension of Time - one month (in duplicate);
3. Check in the amount of \$430.00 for the Notice of Appeal filing fee (\$320.00) and one-month extension fee (\$110.00); and
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Date: 9-3-02

  
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